



Vantageo Enterprise Storage - 24XP-24ST





Key Features

- 1. Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600 v4†/ v3 family; QPI up to 9.6GT/s
- 2. Up to 2TB⁺ ECC 3DS LRDIMM, up to DDR4- 2400⁺MHz; 16x DIMM slots
- 3. 1 PCI-E 3.0 x16, 6 PCI-E 3.0 x8 (slot 1 & 2 occupied by controller and JBOD expansion port)
- 4. Dual 10GBase-T LAN w/Intel® X540
- 5. 24x 3.5" Hot-swap SAS3 (with Broadcom expander) / SATA3 drive bays; 2x 2.5" optional Hot-swap SATA drive bays (rear)
- 6. 6.SAS3 via Broadcom 3008 controller; IT mode
- 7. Server remote management: IPMI 2.0 / KVM over LAN / Media over LAN
- 8. 8.2x 80mm hot-swap rear exhaust PWM fans
- 9. 9.920W Redundant Power Supplies Platinum Level (94%)



SPECIFICATIONS						
Chassis						
Form Factor	4U Rackmount	Model	24XP-24\$T			
Processor / Cache						
CPU	• Intel® Xeon® processor E5-2600 v4†/ v3 family (up to 145W TDP) *					
	Dual Socket R3 (LGA 2011)					
Cores / Cache	Up to 22 Cores† / Up to 55MB† Cache					
System Bus	QPI up to 9.6 GT/s					
Note	† BIOS version 2.0 or above is required					
Note	* Please contact Vantageo Technical Support for additional information about frequency optimized CPUs and specialized system optimization.					
Dimensions						
Width	17.2" (437mm)	Height	7" (178mm)			
Weight	Net Weight: 55 lbs (24.9 kg) Gross Weight: 92 lbs (41.7 kg)	Avaiable Colors	Black			
Depth	26.5" (673mm)					
Front Panel						
Buttons	Power On/Off button		System Reset button			
	Power status LED		2 Network activity LEDs			
LED's	Hard drive activity LED		System Information LED			
	Power fail LED					
	Di	ive Bays				
Hot-Swap	24x 3.5" Hot-swap SAS3/SATA3 drive baysdrive bays					
Optional	2x 2.5" Hot-swap SATA drive bays (rear)					
	Syste	em Memory				
Memory Capacity	16x 288-pin DDR4 DIMM slots					
Memory Capacity	Up to 2TB† ECC 3DS LRDIMM, 512GB ECC RDIMM					
Memory Type	• 2400†/2133/1866/1600MHz ECCDDR4 SDRAM 72-bit					
DIMM Sizes	3DS LRDIMM: 128GB	• LRDIMM: 64GB, 32GB	• RDIMM: 64GB, 32GB, 16GB, 8GB, 4GB			
Memory Voltage	1.2V	Error Detection	Corrects single-bit errors			
	Expo	ansion Slots				
PCI - Express	• 1 PCI-E 3.0 x16 slot		• 6 PCI-E 3.0 x8 slots			
	Slot 1 & 2 occupied by controller and JBOD Expansion Port					
Backplane Backplane						
SAS3/SATA3 single expander per backplane						

System Cooling

• Redundant cooling

• 2x 80mm hot-swap rear exhaust cooling

Fans

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On-Board Devices							
Chipset	Intel® C612 chipset						
SAS	SAS3 (12Gbps) via Broadcom 3008		IT mode firmware				
SATA	SATA3 (6Gbps) with RAID 0, 1, 5, 10						
Graphics	ASPEED AST2400 BMC						
Network Controllers	Intel® X540 Dual Port 10GbE		Virtual Machine Device Queues reduce I/O overhea				
	Supports 10GBASE-T, 100BASE-TX, and 1000BASE-T, RJ45 output RJ45 output		Realtek RTL8201N PHY (dedicated IPMI)				
IPMI	ASPEED AST2400 BMC		Support for Intelligent Platform Management Interfact v.2.0				
	IPMI 2.0 with virtual media over LAN an	d KVM-over-LAN					
Input / Output							
LAN	1 RJ45 Dedicated IPMI LAN port		• 2 RJ45 10GBase-T LAN ports				
VGA	• 1 VGA port						
USB	• 2 USB 3.0 ports (rear)	• 1 Type A	• USB 2.0 ports (rear)				
Serial Port / Header	1 Fast UART 16550 port / 1 Header						
	S	ystem BIOS					
BIOS Type	128Mb SPI Flash EEPROM with AMI BIOS						
Nos Fuel	Plug and Play (PnP)		• APM 1.2				
	• PCI 2.2		• ACPI 1.0 / 2.0				
BIOS Features	USB Keyboard support		• SMBIOS 2.3				
	• UEFI						
Power Supply with F	Power Distributor Redundant High-Efficiency Power Supp	olies w/ Power D	920\ istributor, PMBus 1.2, I2C, and PFC				
AC Input	100-240 V, 50-60 Hz, 11-4.5 Amp						
DC Output	• +5V standby: 4A		• +12V: 75A				
With Power Distributor	• +3.3V: 24A	• +5V: 45A	• -12V: 0.6A				
Certification Platinum Certified [Test Report]							



Operating Environment						
RoHS	RoHS Compliant					
Operating Temperature Range	10°C to 35°C (50°F to 95°F)	Non-Operating Temperature Range	- 40°C to 70°C (-40°F to 158°F)			
Operating Relative Humidity Range	8% to 90% (non-condensing)	Non-Operating Relative Humidily Range	5% to 95% (non-condensing)			

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